## DESIGN OF LITHOGRAPHY ALIGNMENT AND OVERLAY MEASUREMENT MARKS ON CMP FINISHED DAMASCENE SURFACE

## 5 ABSTRACT

A method for producing a semiconductor device having an alignment mark, the method comprising forming a first dielectric layer within which a trench having predetermined dimensions is etched and depositing a first layer of metal into the trench; forming a second dielectric layer over the first dielectric layer and over the first layer of metal; simultaneously etching lines and an opening into the second dielectric layer, at least one line used as a via extending to the first layer of 15 metal; filling the lines and the opening, the filling controlled to fill the lines and to under fill the opening; performing chemical mechanical polishing of the plate; and depositing a non-transparent stack of layers onto the metal, whereby the non-transparent stack of layers conforms to the surface of the under filled 20 opening resulting in an alignment mark on the nontransparent stack of layers in order to aller successive lavers.